&TDK Multilayer Ceramic Chip Capacitors

CGA3E2C0G1H122J080AE

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TDK item description CGA3E2C0G1H122JT***S

Applications	Automotive Grade	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~
Feature	Soft Soft Termination AEC-Q200 AEC-Q200	
Series	CGA3(1608) [EIA 0603]	B
Status	Production	

Size		
Length(L)	1.60mm +0.20,-0.10mm	
Width(W)	0.80mm +0.15,-0.10mm	
Thickness(T)	0.80mm +0.15,-0.10mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)	0.30mm Min.	
Recommended Land Pattern (PA)	0.70mm to 1.00mm(Flow Soldering)	
	0.60mm to 0.80mm(Reflow Soldering)	
Recommended Land Pattern (PB)	0.80mm to 1.00mm(Flow Soldering)	
	0.60mm to 0.80mm(Reflow Soldering)	
Recommended Land Pattern (PC)	0.60mm to 0.80mm(Flow Soldering)	
	0.60mm to 0.80mm(Reflow Soldering)	

Electrical Characteristics			
Capacitance	1.2nF ±5%		
Rated Voltage	50VDC		
Temperature Characteristic	C0G(0±30ppm/°C)		
Q (Min.)	1000		
Insulation Resistance (Min.)	10000ΜΩ		

Other		
Coldoring Method	Wave (Flow)	
Soldering Method	Reflow	
AEC-Q200	Yes	
Packing	Punched (Paper)Taping [180mm Reel]	
Package Quantity	4000pcs	

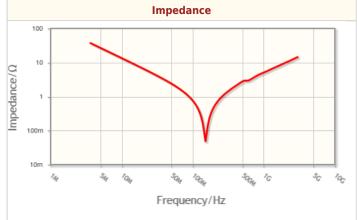
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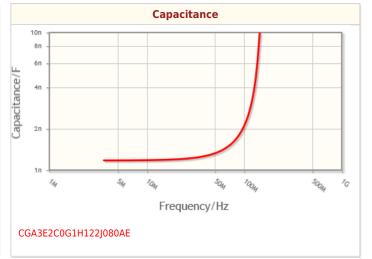
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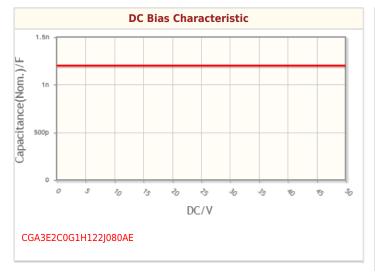


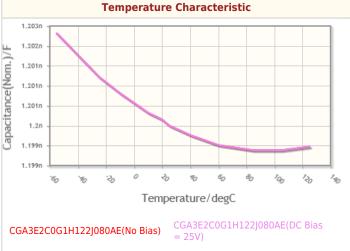


Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)









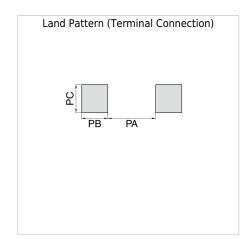
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Associated Images



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